

# **TPS55330EVM-017 2.9-V to 4.2-V Input, 5.0-V Output Boost Evaluation Module**

This user's guide contains information for the TPS55330EVM-017 evaluation module (EVM) as well as the TPS55330 DC/DC converter. The document includes the performance specifications, schematic, and the bill of materials for the TPS55330EVM-017.

## **Contents**

1	Background .....	2
2	Performance Specification Summary .....	2
3	Modifications .....	2
4	Test Setup and Results .....	3
5	Board Layout .....	11
6	Schematic and Bill of Materials .....	14

## **List of Figures**

1	TPS55330EVM-017 Efficiency .....	4
2	TPS55330EVM-017 Output Voltage Load Regulation .....	4
3	TPS55330EVM-017 Output Voltage Line Regulation .....	5
4	TPS55330EVM-017 $V_{IN} = 3.6\text{-V}$ Transient Response .....	5
5	TPS55330EVM-017 Loop Response .....	6
6	TPS55330EVM-017 $V_{IN} = 3.6\text{-V}$ Output Ripple .....	6
7	TPS55330EVM-017 DCM Output Ripple .....	7
8	TPS55330EVM-017 $V_{IN} = 3.6\text{-V}$ Pulse-Skipping .....	7
9	TPS55330EVM-017 $V_{IN} = 5\text{-V}$ Input Voltage Ripple .....	8
10	TPS55330EVM-017 $V_{IN} = 3.6\text{-V}$ Input Voltage Ripple .....	8
11	TPS55330EVM-017 Power Up With EN .....	9
12	TPS55330EVM-017 Power Down With EN .....	9
13	TPS55330EVM-017 Power Up With $V_{IN}$ .....	10
14	TPS55330EVM-017 Power Down With $V_{IN}$ .....	10
15	TPS55330EVM-017 Top-Side Assembly .....	11
16	TPS55330EVM-017 Top-Side Layout .....	12
17	TPS55330EVM-017 Internal Layer-1 Layout .....	12
18	TPS55330EVM-017 Internal Layer-2 Layout .....	13
19	TPS55330EVM-017 Bottom-Side Layout .....	13
20	TPS55330EVM-017 Schematic .....	14

## **List of Tables**

1	Input Voltage and Output Current Summary .....	2
2	Performance Specification Summary .....	2
3	EVM Connectors and Test Points .....	3
4	TPS55330EVM-017 Bill of Materials .....	15

## 1 Background

The TPS55330 DC/DC converter is a step-up boost converter. Rated input voltage and output current range for the evaluation module are given in [Table 1](#). This EVM demonstrates the performance of the TPS55330 in an example application and accommodates evaluation of other boost applications supported by the TPS55330. This design shows that a small printed-circuit-board area is possible when designing with the TPS55330 regulator. However, appropriate sizing of the inductor and diode for the desired application can further reduce the board area. The switching frequency is externally set at a nominal 600 kHz. The 24-V, 5-A, low-side MOSFET is incorporated inside the TPS55330 package along with the gate-drive circuitry. The low drain-to-source on-resistance of the MOSFET achieves high efficiencies with the TPS55330. The compensation components are external to the integrated circuit (IC). The absolute maximum input voltage is 18 V for the EVM.

**Table 1. Input Voltage and Output Current Summary**

EVM	Input Voltage Range	Maximum Output Current
TPS55330EVM-017	$V_{IN} = 2.9 \text{ V to } 4.2 \text{ V}$	$I_{OUTmax} = 2.1 \text{ A}$

## 2 Performance Specification Summary

[Table 2](#) provides a summary of the EVM performance specifications. Specifications are given for an input voltage of  $V_{IN} = 3.6 \text{ V}$  with an output voltage of 5 V, unless otherwise specified. The ambient temperature is 25°C for all measurements, unless otherwise noted.

**Table 2. Performance Specification Summary**

Specification	Test Conditions		Min	Typ	Max	Unit
$V_{IN}$ voltage range			2.9	3.6	4.2	V
Output voltage set point			5			V
Line regulation	$I_{OUT} = 2.1 \text{ A}, V_{IN} = 2.9 \text{ V to } 4.2 \text{ V}$		$\pm 0.1\%$			
Operating frequency			600			kHz
Output current range			0.001	2.1		A
Load regulation	$I_{OUT} = 1 \text{ mA to } 2.1 \text{ A}$		$\pm 0.1\%$			
Load transient response	$I_{OUT} = 525 \text{ mA to } 1.575 \text{ A}$	Voltage change	-220			mV
		Recovery time	400			$\mu\text{s}$
	$I_{OUT} = 1.575 \text{ A to } 525 \text{ mA}$	Voltage change	180			mV
		Recovery time	400			$\mu\text{s}$
Loop bandwidth	$I_{OUT} = 2.1 \text{ A}$		10			kHz
Phase margin	$I_{OUT} = 2.1 \text{ A}$		76			°
Output ripple voltage	$I_{OUT} = 2.1 \text{ A}$		20			mVpp
Maximum efficiency	TPS55330EVM-017, $V_{IN} = 4.2 \text{ V}, I_{OUT} = 700 \text{ mA}$		92.5%			

## 3 Modifications

These evaluation modules provide access to the features of the TPS55330. Some modifications to this module are possible.

### 3.1 Output Voltage Set Point

The resistor divider network of R1 and R2 sets the output voltage. Keep R2 fixed at or close to 10 k $\Omega$ . Change the output voltage of the EVM by changing the value of resistor R1. Calculate the value of R1 for a specific output voltage by using [Equation 1](#).

$$R1 = R2 \times \left( \frac{V_{OUT}}{1.229V} - 1 \right) \quad (1)$$

Note that  $V_{IN}$  must be in a range so that the on-time is greater than the minimum controllable on-time (77 ns typical), and the maximum duty cycle is less than 89% minimum and 93% typical.

### 3.2 Maximum Output Current

After adjusting input or output voltage settings, verify the maximum output current pursuant to the equations given on the data sheet ([SLVSBX8](#)).

### 3.3 Slow-Start Time

Adjust the slow-start time by changing the value of C3. The EVM uses  $C3 = 0.047 \mu\text{F}$ , as recommended on the data sheet, avoiding any overshoot during start-up. A larger capacitance increases the slow-start time while a smaller capacitance decreases it.

### 3.4 Other Modifications

Please see data sheet recommendations and equations when changing the switching frequency, input/output voltage range, input inductor, output capacitors or compensation.

## 4 Test Setup and Results

This section describes how to properly connect, set up, and use the EVM. Included are test results typical for the evaluation module covering efficiency, output voltage regulation, load transients, loop response, output ripple, input ripple, start-up and shut-down.

### 4.1 Input/Output Connections

The EVM is provided with input and output connectors and test points as shown in [Table 3](#). Connect a power supply capable of supplying 5 A to J6 through a pair of 20-AWG wires. The jumper across JP1 in the ON position (1-2) must be in place. Connect the load to J7 through a pair of 20-AWG wires. The maximum load-current capability must be at least 2.1 A. Minimize wire lengths to reduce losses in the wires. Header J1 provides a place to monitor the  $V_{\text{IN}}$  input voltages with J3 providing a convenient ground reference. Use J2 to monitor the output voltage with J4 as the ground reference.

**Table 3. EVM Connectors and Test Points**

Reference Designator	Function
J1	2-pin header for $V_{\text{IN}}$ input voltage connections
J2	2-pin header for $V_{\text{OUT}}$ input voltage connections
J3, J4	2-pin header for GND connections
J5	2-pin header for synchronizing signal and ground
J6	$V_{\text{IN}}$ input voltage connector. (See <a href="#">Table 1</a> for $V_{\text{IN}}$ range.)
JP1	3-pin header for enable. Jumper installed from pins 1-2 enables and from pins 2-3 disables.
TP1	SW test point
TP2	Test point between voltage divider network and output. Used for loop-response measurements.
TP3	COMP test point
TP4	Output voltage test point at $V_{\text{OUT}}$ connector
TP5	GND test point at $V_{\text{OUT}}$ connector

## 4.2 Efficiency

The efficiency of this EVM peaks at a load current of about 400 mA at 2.9-V input and 700 mA at 4.2-V input, then decreases as the load current increases toward full load. Figure 1 shows the efficiency for the EVM at an ambient temperature of 25°C.

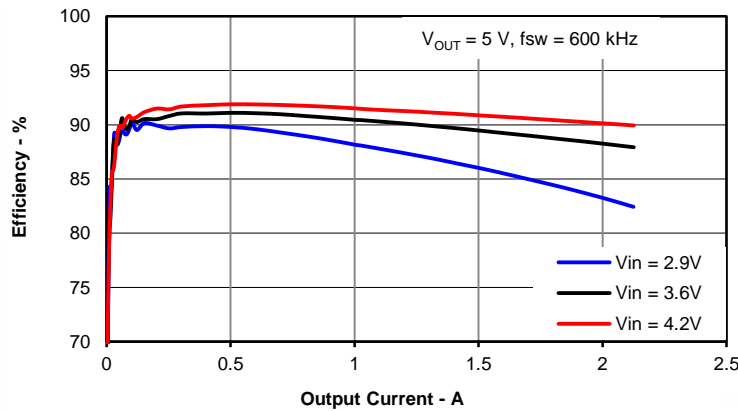


Figure 1. TPS55330EVM-017 Efficiency

The efficiency may be lower at higher ambient temperatures, due to temperature variation in the drain-to-source resistance of the internal MOSFET.

## 4.3 Output Voltage Load Regulation

Figure 2 shows the load regulation for the EVM.

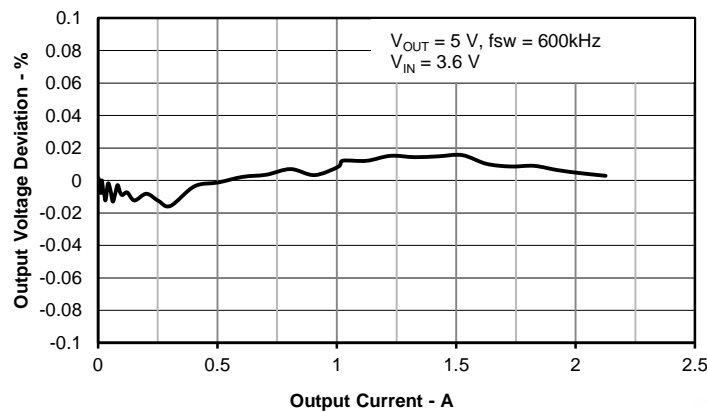


Figure 2. TPS55330EVM-017 Output Voltage Load Regulation

Measurements are for an ambient temperature of 25°C.

### 4.4 Output Voltage Line Regulation

Figure 3 shows the line regulation for the EVM with a 2.4-Ω (2.1 A) load.

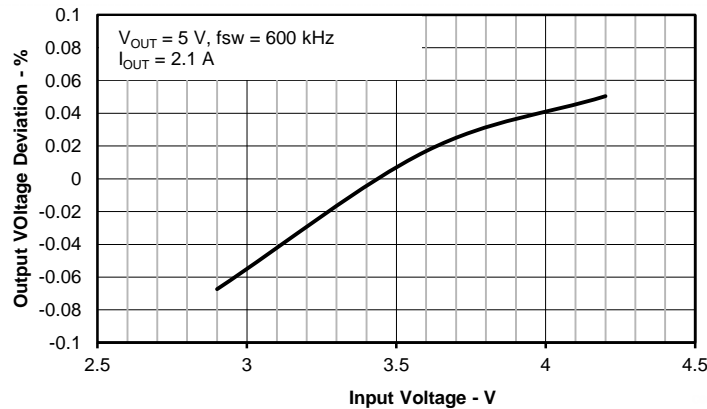


Figure 3. TPS55330EVM-017 Output Voltage Line Regulation

### 4.5 Load Transients

Figure 4 shows the EVM's response to load transients. The current step is from 25% to 75% of maximum rated load at a 3.6-V input respectively. The current step slew rate is 100 mA/μs. Total peak-to-peak voltage variation is as shown, including ripple and noise on the output.

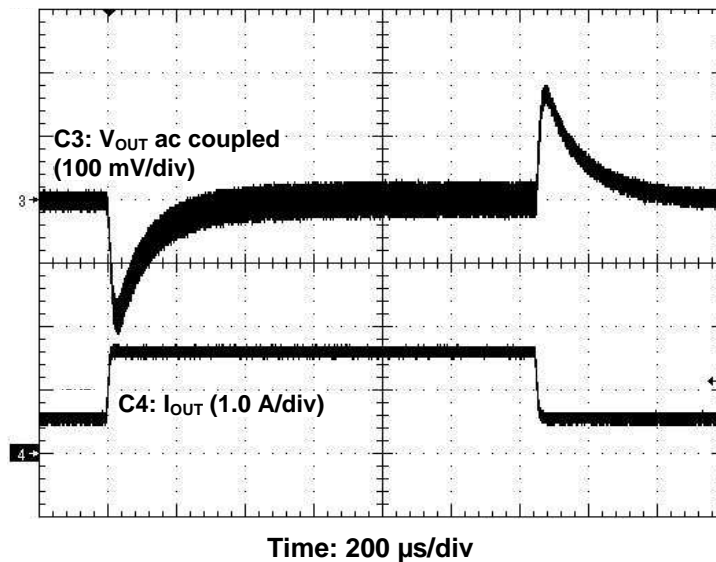


Figure 4. TPS55330EVM-017  $V_{IN} = 3.6\text{-V}$  Transient Response

### 4.6 Loop Characteristics

Figure 5 shows the EVM loop-response characteristics. Gain and phase plots are shown for  $V_{IN}$  voltage of 3.6 V with load current of 2.1 A.

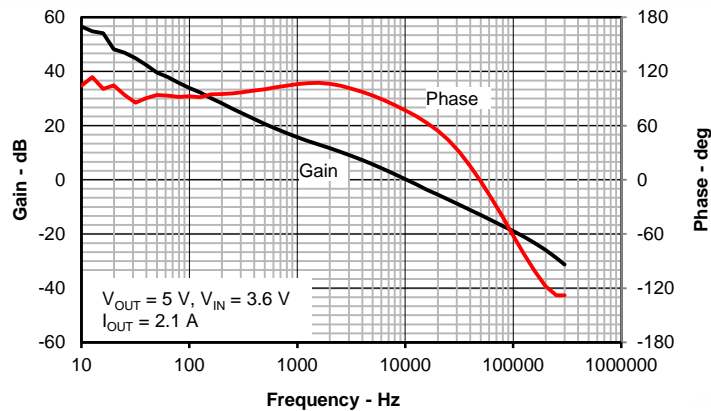


Figure 5. TPS55330EVM-017 Loop Response

### 4.7 Output Voltage Ripple

Figure 6 shows the EVM output voltage ripple and inductor current ripple. The output current is the rated full load of 2.1 A and  $V_{IN} = 3.6$  V. The ripple voltage is measured directly across the output capacitors.

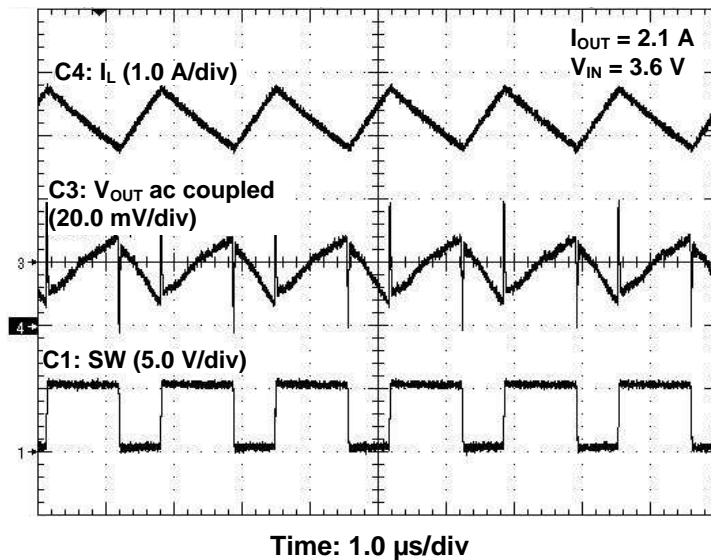


Figure 6. TPS55330EVM-017  $V_{IN} = 3.6$ -V Output Ripple

Figure 7 shows the EVM output voltage ripple, inductor current ripple and switching waveform while operating in discontinuous conduction mode (DCM). The input voltage is 3.6 V and the output is loaded with 100 mA.

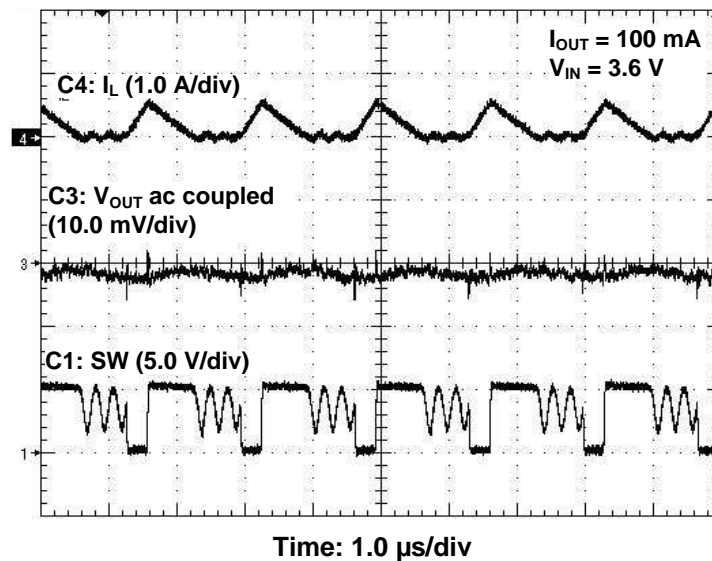


Figure 7. TPS55330EVM-017 DCM Output Ripple

#### 4.8 Pulse-Skipping Operation

The TPS55330 features pulse-skipping for output regulation when operating at light loads. Figure 7 shows the output voltage ripple and the pulse-skipping at SW. The input voltage is 3.6 V.

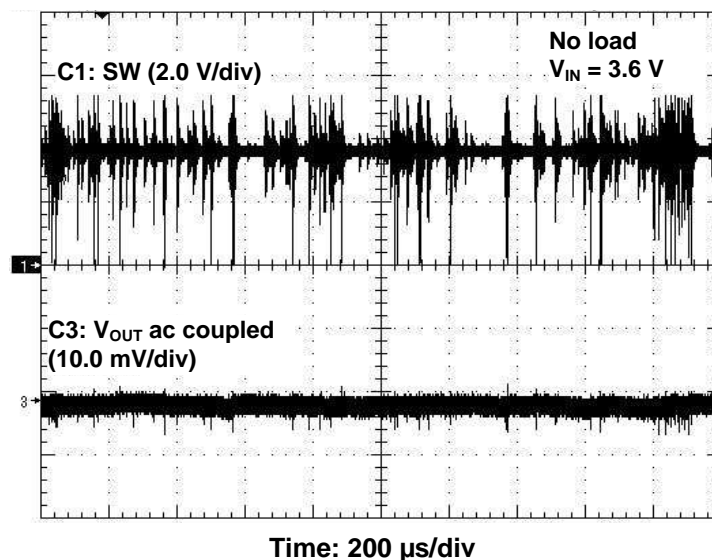


Figure 8. TPS55330EVM-017  $V_{IN} = 3.6\text{-V}$  Pulse-Skipping

## 4.9 Input Voltage Ripple

Figure 9 shows the EVM input voltage ripple at rated full load of 2.1 A at  $V_{IN} = 3.6$  V. The ripple is measured directly across the input capacitor, C2.

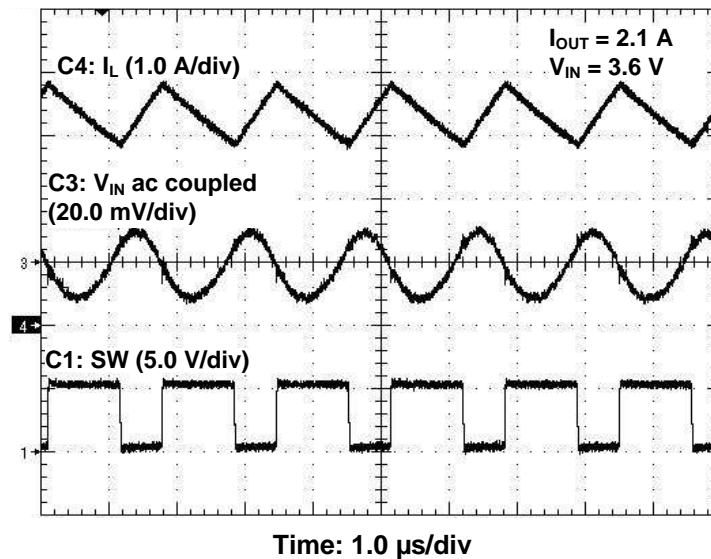


Figure 9. TPS55330EVM-017  $V_{IN} = 5$ -V Input Voltage Ripple

Figure 10 shows the EVM input voltage ripple in DCM operation with a 100 mA load at  $V_{IN} = 3.6$  V. The ripple is measured directly across the input capacitor, C2.

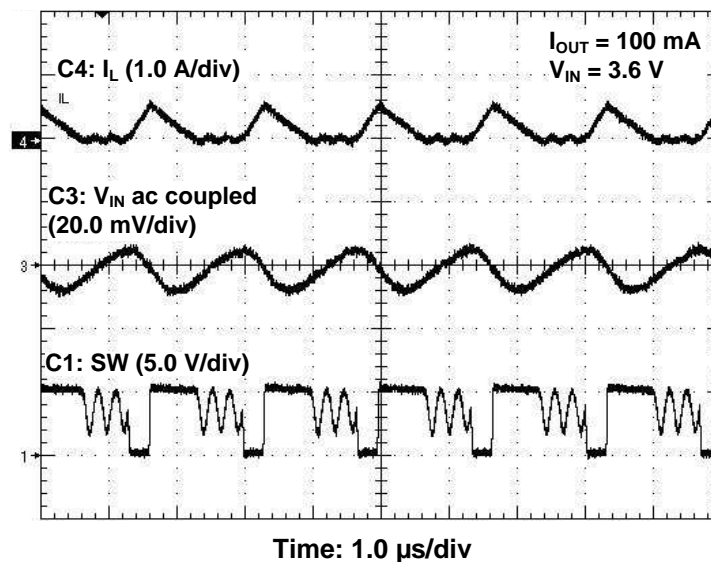


Figure 10. TPS55330EVM-017  $V_{IN} = 3.6$ -V Input Voltage Ripple



#### 4.10 Powering Up and Down with EN

Figure 11 shows the start-up waveforms for the EVM. The input voltage is 3.6 V, the EN goes high and the output voltage ramps from  $V_{IN}$  to 5 V. The load is 2.1 A.

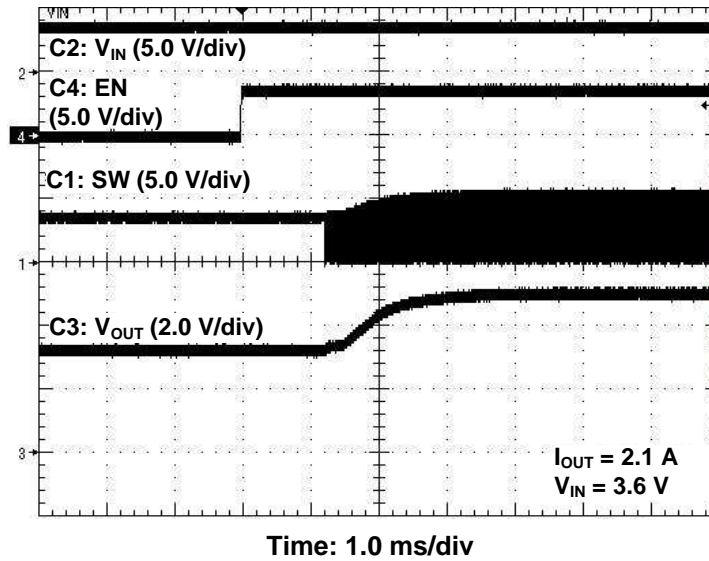


Figure 11. TPS55330EVM-017 Power Up With EN

Figure 12 shows the shutdown waveforms for the EVM. The input voltage is 3.6 V. The EN goes low and the output voltage ramps from 5 V to  $V_{IN}$ . The load is 2.1 A.

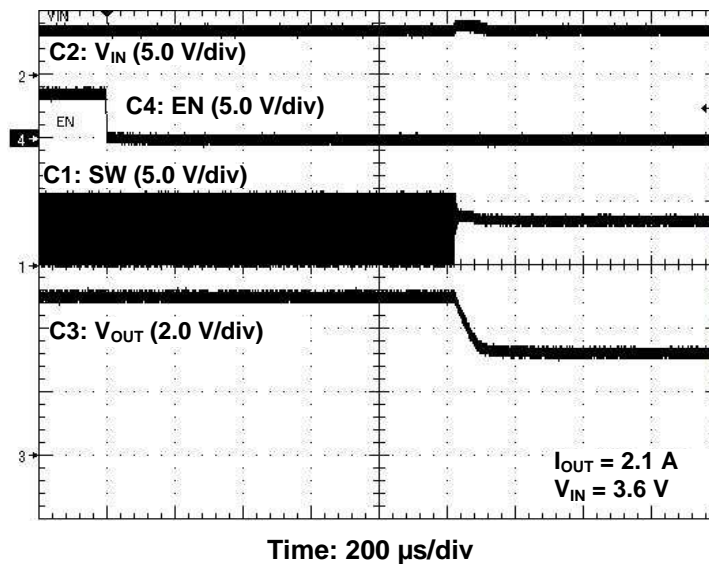


Figure 12. TPS55330EVM-017 Power Down With EN

#### 4.11 Powering Up and Down with $V_{IN}$

Figure 13 shows the start-up waveforms for the EVM. The input voltage ramps with the input voltage power supply and EN is tied to  $V_{IN}$ .  $V_{IN}$  ramps up, the converter starts switching and the output voltage ramps to 5 V. The load is 2.1 A.

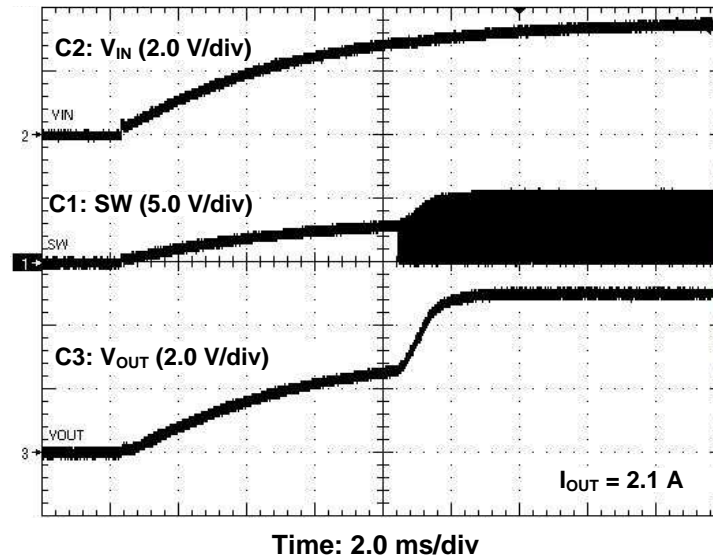


Figure 13. TPS55330EVM-017 Power Up With  $V_{IN}$

Figure 14 shows the shutdown waveforms for the EVM. The input voltage ramps down with the input voltage power supply and EN is tied to  $V_{IN}$ . When  $V_{IN}$  is less than the 2.5-V typical UVLO, the converter stops switching and the output voltage ramps down. The load is 2.1 A.

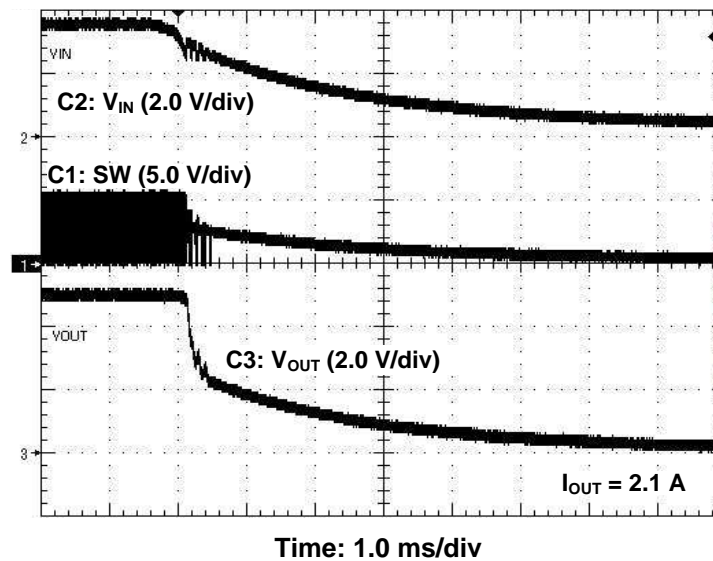


Figure 14. TPS55330EVM-017 Power Down With  $V_{IN}$

## 5 Board Layout

This section provides a description of the EVM board layout and layer illustrations.

### 5.1 Layout

The board layout for the EVM is shown in Figure 15 through Figure 19. The top-side layer of the EVM is laid out in a manner typical of a user application. The top, bottom, and internal layers are 2-oz. copper.

The top layer contains the main power traces for  $V_{IN}$ ,  $V_{OUT}$ , and SW. Also on the top layer are connections for the remaining pins of the TPS55330 and a large area filled with ground. The internal layers and bottom are primarily ground with additional fill areas for  $V_{IN}$  and  $V_{OUT}$ . The top-side ground traces connect to the bottom and internal ground planes with multiple vias placed around the board. Nine vias directly under the TPS55330 device provide a thermal path from the top-side ground plane to the bottom-side ground plane.

Place the output decoupling capacitors (C8–C11) as close to the IC as possible. The copper area of the SW node is kept small, minimizing noise. The vias near the diode, D1, on the  $V_{OUT}$  plane aid with thermal dissipation. Additionally, keep the voltage setpoint resistor divider components close to the IC. The voltage divider network ties to the output voltage at the point of regulation, the copper  $V_{OUT}$  trace at the J7 output connector. For the TPS55330, an additional input bulk capacitor may be necessary, depending on the EVM connection to the input supply. Critical analog circuits such as the voltage setpoint divider, frequency set resistor, slow-start capacitor, and compensation components terminate to ground using a separate ground trace on the top and bottom connected power ground, pour only at one point directly under the IC.

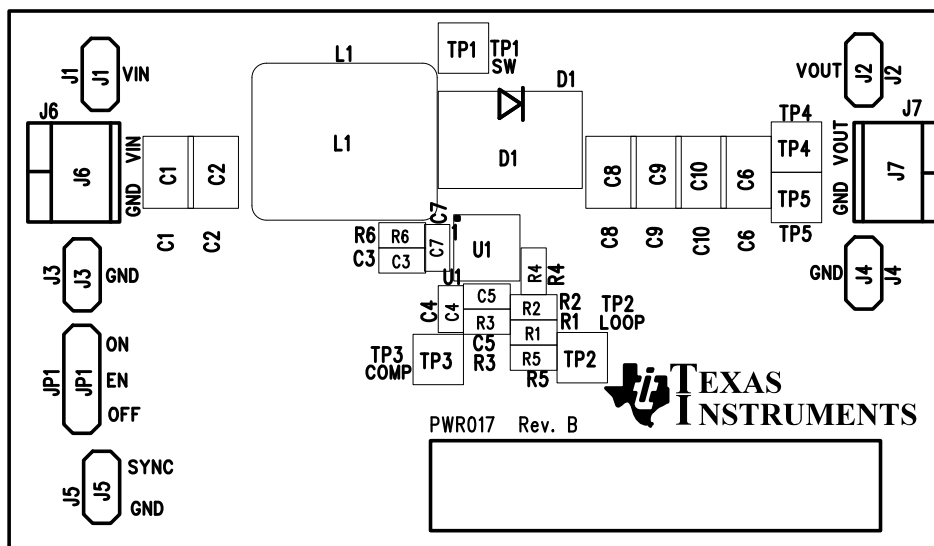


Figure 15. TPS55330EVM-017 Top-Side Assembly

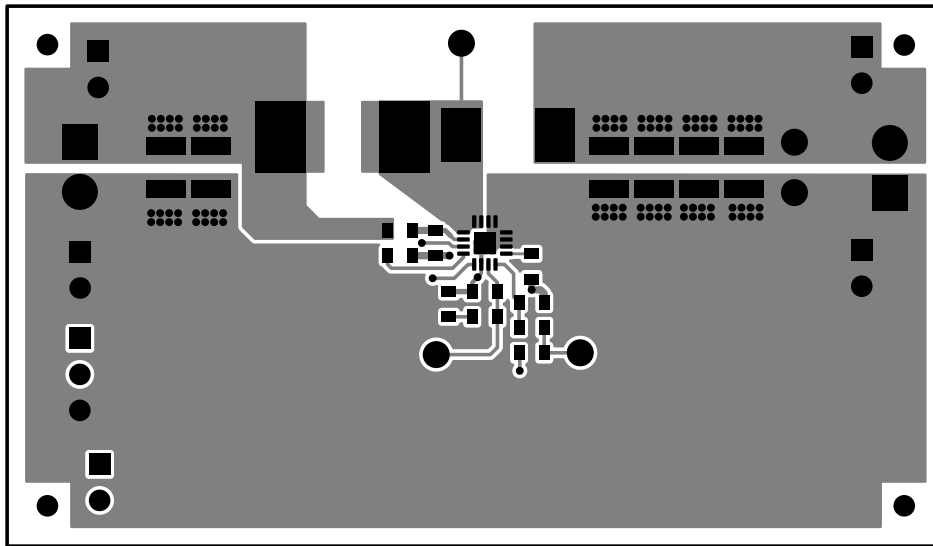


Figure 16. TPS55330EVM-017 Top-Side Layout

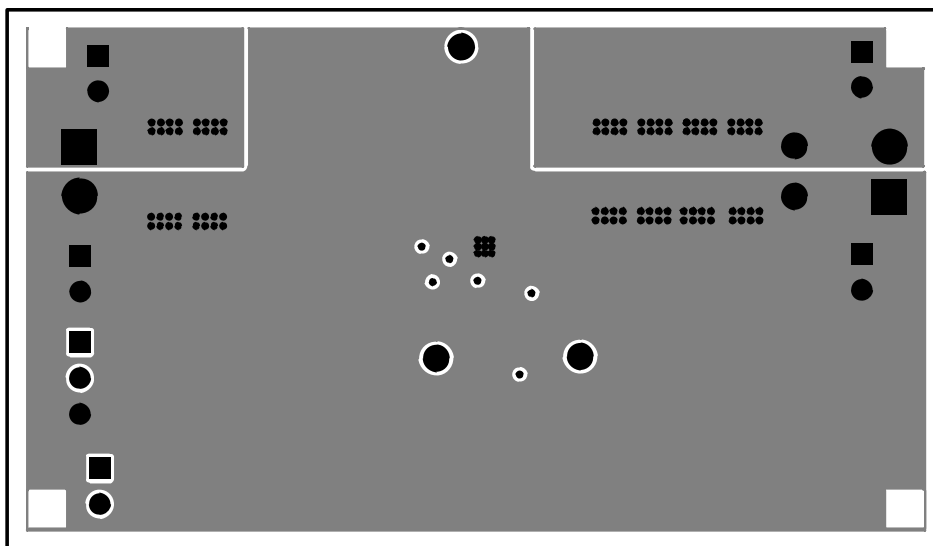


Figure 17. TPS55330EVM-017 Internal Layer-1 Layout

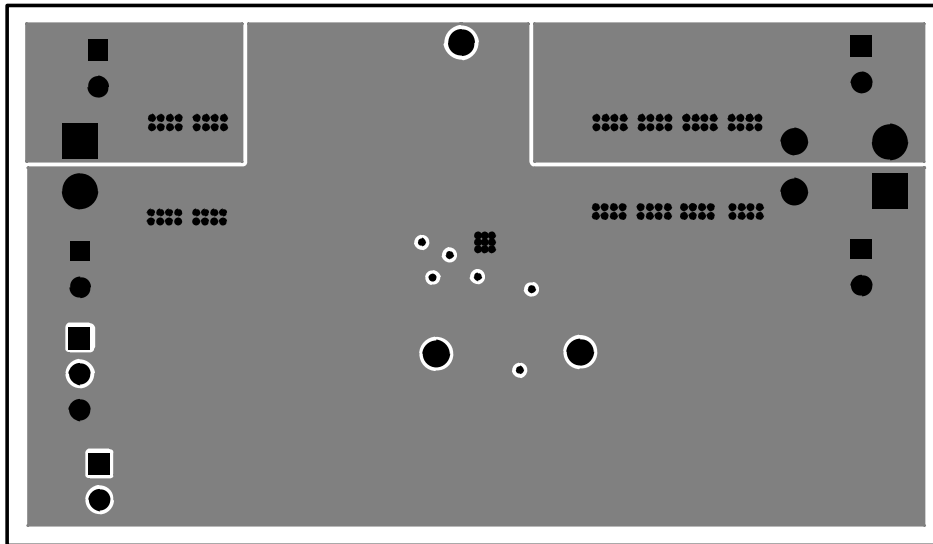


Figure 18. TPS55330EVM-017 Internal Layer-2 Layout

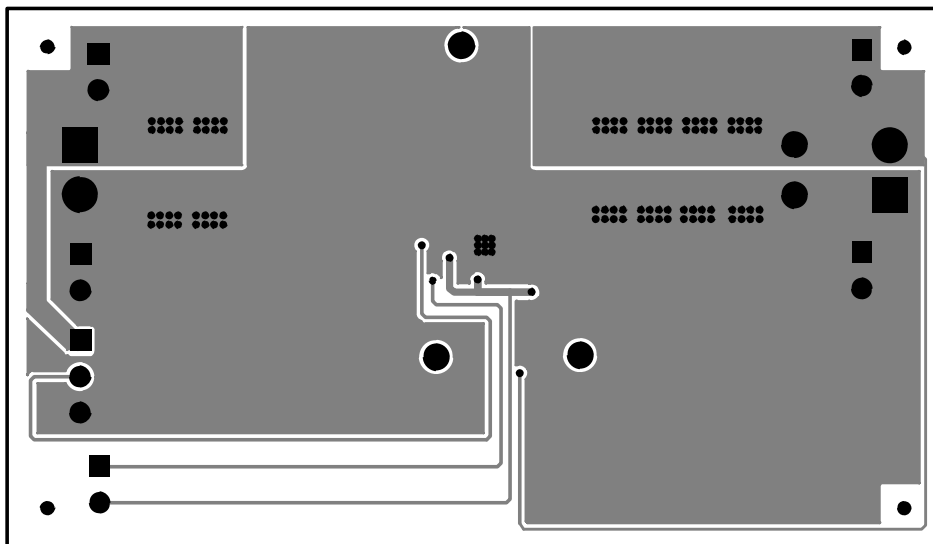


Figure 19. TPS55330EVM-017 Bottom-Side Layout

## 6 Schematic and Bill of Materials

This section presents the EVM schematic and bill of materials.

### 6.1 Schematic

Figure 20 is the schematic for the EVM.

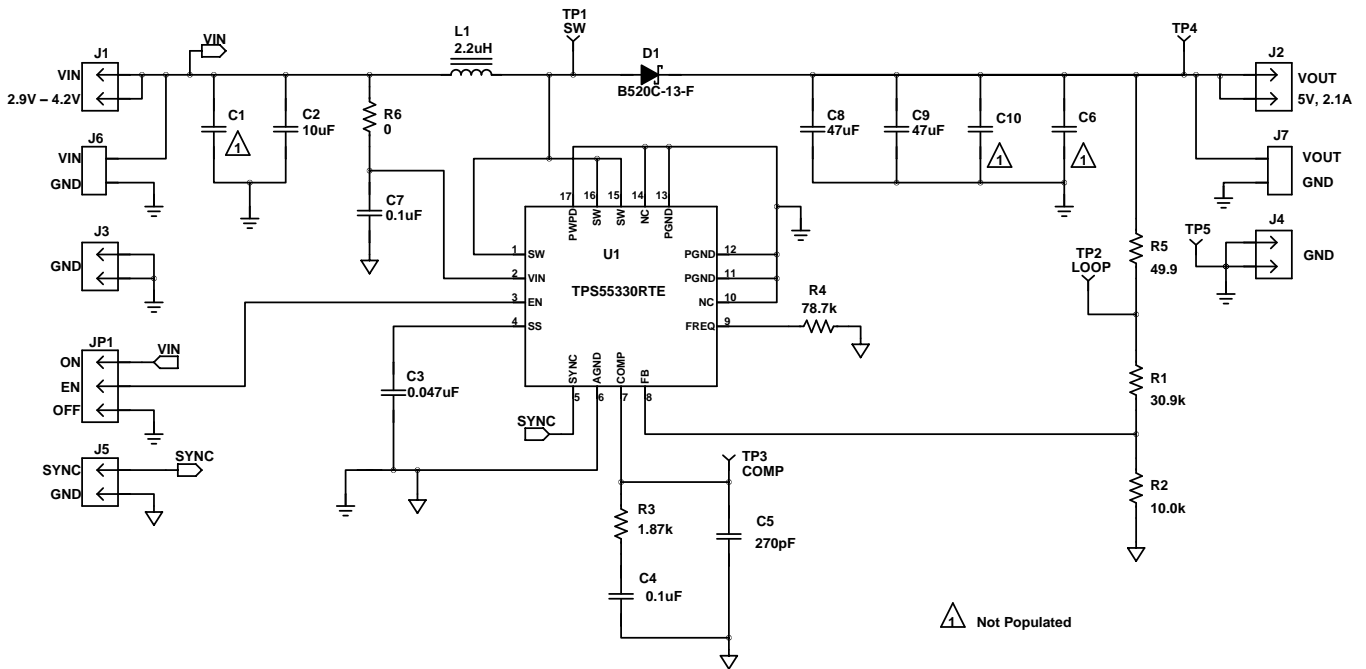


Figure 20. TPS55330EVM-017 Schematic

## 6.2 Bill of Materials

Table 4 presents the bill of materials for the EVM.

**Table 4. TPS55330EVM-017 Bill of Materials**

QTY	RefDes	Value	Description	Size	Part Number	MFR
0	C1	Open	Capacitor, ceramic	1210	STD	STD
1	C2	10 $\mu$ F	Capacitor, ceramic, 35 V, X7R, 10%	1210	STD	STD
1	C3	0.047 $\mu$ F	Capacitor, ceramic, 50 V, X7R, 10%	0603	STD	STD
1	C4	0.1 $\mu$ F	Capacitor, ceramic, 50 V, X7R, 10%	0603	STD	STD
1	C5	270 pF	Capacitor, ceramic, 50 V, NP0, 10%	0603	STD	STD
0	C6, C10	Open	Capacitor	1210	STD	STD
1	C7	0.1 $\mu$ F	Capacitor, ceramic, 50 V, X7R, 10%	0603	STD	STD
2	C8-C9	47 $\mu$ F	Capacitor, ceramic, 16 V, X7R, 10%	1210	STD	STD
1	D1	B520C-13-F	Diode, Schottky, 5 A, 20 V	SMC	B520C-13-F	Diodes Inc
5	J1-5	PEC025AAN	Header, Male 2-pin, 100 mil spacing	0.100 x 2 in	PEC025AAN	Suffins
2	J6-7	ED555/2DS	Terminal block, 2 pin, 6 A, 3.5 mm	0.27 x 0.25 in	ED555/205	OST
1	JP1	PEC035AAN	Header, Male 3 pin, 100 mil spacing	0.100 x 3 in	PEC035AAN	Sullins
1	L1	2.2 $\mu$ H	Inductor, SMT, 6.5 A, 18 m $\Omega$	0.287 x 0.160 in	74437346022	Würth Elektronik
1	R1	30.9 k $\Omega$	Resistor, chip, 1/16W, 1%	0603	STD	STD
1	R2	10.0 k $\Omega$	Resistor, chip, 1/16W, 1%	0603	STD	
1	R3	1.87 k $\Omega$	Resistor, chip, 1/16W, 1%	0603	STD	
1	R4	78.7 k $\Omega$	Resistor, chip, 1/16W, 1%	0603	STD	
1	R5	49.9 $\Omega$	Resistor, chip, 1/16W, 1%	0603	STD	
1	R6	0 $\Omega$	Resistor, chip, 1/16W, 1%	0603	STD	
1	SH1		Short jumper, 100 mil	0.100 in	929950-00	3M
1	TP5	5001	Test point, black, Thru Hole Color Keyed	0.100 x 0.100 in		Keystone
4	TP1-4	5000	Test point, red, thru hole color keyed	0.100 x 0.100 in		Keystone
1	U1	TPS55330RTE	IC, 5-A, 24-V, Boost Converter with Soft-start and Programmable Switching Frequency	QFN-16	TPS55330RTE	TI
1	--		PCB, 2.6 in x 1.5 in x 0.062 in		PWR017	Any

Notes: 1. These assemblies are ESD sensitive, observe ESD precautions.  
2. These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.  
3. These assemblies must comply with workmanship standards IPC-A-610 Class 2.  
4. Ref designators marked with an asterisk (\*\*\*) cannot be substituted. All other components can be substituted with equivalent MFG's components.

## 6.3 Reference

1. *TPS55330, Integrated 5-A 24-V Boost/SEPIC/Flyback DC-DC Regulator* data sheet ([SLVSBX8](#))

## EVALUATION BOARD/KIT/MODULE (EVM) ADDITIONAL TERMS

Texas Instruments (TI) provides the enclosed Evaluation Board/Kit/Module (EVM) under the following conditions:

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## REGULATORY COMPLIANCE INFORMATION

As noted in the EVM User's Guide and/or EVM itself, this EVM and/or accompanying hardware may or may not be subject to the Federal Communications Commission (FCC) and Industry Canada (IC) rules.

For EVMs **not** subject to the above rules, this evaluation board/kit/module is intended for use for ENGINEERING DEVELOPMENT, DEMONSTRATION OR EVALUATION PURPOSES ONLY and is not considered by TI to be a finished end product fit for general consumer use. It generates, uses, and can radiate radio frequency energy and has not been tested for compliance with the limits of computing devices pursuant to part 15 of FCC or ICES-003 rules, which are designed to provide reasonable protection against radio frequency interference. Operation of the equipment may cause interference with radio communications, in which case the user at his own expense will be required to take whatever measures may be required to correct this interference.

### General Statement for EVMs including a radio

*User Power/Frequency Use Obligations:* This radio is intended for development/professional use only in legally allocated frequency and power limits. Any use of radio frequencies and/or power availability of this EVM and its development application(s) must comply with local laws governing radio spectrum allocation and power limits for this evaluation module. It is the user's sole responsibility to only operate this radio in legally acceptable frequency space and within legally mandated power limitations. Any exceptions to this are strictly prohibited and unauthorized by Texas Instruments unless user has obtained appropriate experimental/development licenses from local regulatory authorities, which is responsibility of user including its acceptable authorization.

### For EVMs annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant

#### Caution

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

### FCC Interference Statement for Class A EVM devices

This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.



### **FCC Interference Statement for Class B EVM devices**

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

### **For EVMs annotated as IC – INDUSTRY CANADA Compliant**

This Class A or B digital apparatus complies with Canadian ICES-003.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

### **Concerning EVMs including radio transmitters**

This device complies with Industry Canada licence-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

### **Concerning EVMs including detachable antennas**

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication.

This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Cet appareil numérique de la classe A ou B est conforme à la norme NMB-003 du Canada.

Les changements ou les modifications pas expressément approuvés par la partie responsable de la conformité ont pu vider l'autorité de l'utilisateur pour actionner l'équipement.

### **Concernant les EVMs avec appareils radio**

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes : (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

### **Concernant les EVMs avec antennes détachables**

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante.

Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur.

## **【Important Notice for Users of EVMs for RF Products in Japan】**

**This development kit is NOT certified as Confirming to Technical Regulations of Radio Law of Japan**

If you use this product in Japan, you are required by Radio Law of Japan to follow the instructions below with respect to this product:

1. Use this product in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
2. Use this product only after you obtained the license of Test Radio Station as provided in Radio Law of Japan with respect to this product, or
3. Use of this product only after you obtained the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to this product. Also, please do not transfer this product, unless you give the same notice above to the transferee. Please note that if you could not follow the instructions above, you will be subject to penalties of Radio Law of Japan.

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## **EVALUATION BOARD/KIT/MODULE (EVM) WARNINGS, RESTRICTIONS AND DISCLAIMERS**

**For Feasibility Evaluation Only, in Laboratory/Development Environments.** Unless otherwise indicated, this EVM is not a finished electrical equipment and not intended for consumer use. It is intended solely for use for preliminary feasibility evaluation in laboratory/development environments by technically qualified electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems and subsystems. It should not be used as all or part of a finished end product.

Your Sole Responsibility and Risk. You acknowledge, represent and agree that:

1. You have unique knowledge concerning Federal, State and local regulatory requirements (including but not limited to Food and Drug Administration regulations, if applicable) which relate to your products and which relate to your use (and/or that of your employees, affiliates, contractors or designees) of the EVM for evaluation, testing and other purposes.
2. You have full and exclusive responsibility to assure the safety and compliance of your products with all such laws and other applicable regulatory requirements, and also to assure the safety of any activities to be conducted by you and/or your employees, affiliates, contractors or designees, using the EVM. Further, you are responsible to assure that any interfaces (electronic and/or mechanical) between the EVM and any human body are designed with suitable isolation and means to safely limit accessible leakage currents to minimize the risk of electrical shock hazard.
3. Since the EVM is not a completed product, it may not meet all applicable regulatory and safety compliance standards (such as UL, CSA, VDE, CE, RoHS and WEEE) which may normally be associated with similar items. You assume full responsibility to determine and/or assure compliance with any such standards and related certifications as may be applicable. You will employ reasonable safeguards to ensure that your use of the EVM will not result in any property damage, injury or death, even if the EVM should fail to perform as described or expected.
4. You will take care of proper disposal and recycling of the EVM's electronic components and packing materials.

**Certain Instructions.** It is important to operate this EVM within TI's recommended specifications and environmental considerations per the user guidelines. Exceeding the specified EVM ratings (including but not limited to input and output voltage, current, power, and environmental ranges) may cause property damage, personal injury or death. If there are questions concerning these ratings please contact a TI field representative prior to connecting interface electronics including input power and intended loads. Any loads applied outside of the specified output range may result in unintended and/or inaccurate operation and/or possible permanent damage to the EVM and/or interface electronics. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative. During normal operation, some circuit components may have case temperatures greater than 60°C as long as the input and output are maintained at a normal ambient operating temperature. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors which can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during normal operation, please be aware that these devices may be very warm to the touch. As with all electronic evaluation tools, only qualified personnel knowledgeable in electronic measurement and diagnostics normally found in development environments should use these EVMs.

**Agreement to Defend, Indemnify and Hold Harmless.** You agree to defend, indemnify and hold TI, its licensors and their representatives harmless from and against any and all claims, damages, losses, expenses, costs and liabilities (collectively, "Claims") arising out of or in connection with any use of the EVM that is not in accordance with the terms of the agreement. This obligation shall apply whether Claims arise under law of tort or contract or any other legal theory, and even if the EVM fails to perform as described or expected.

**Safety-Critical or Life-Critical Applications.** If you intend to evaluate the components for possible use in safety critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, such as devices which are classified as FDA Class III or similar classification, then you must specifically notify TI of such intent and enter into a separate Assurance and Indemnity Agreement.

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TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

### Products

Audio	<a href="http://www.ti.com/audio">www.ti.com/audio</a>
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Clocks and Timers	<a href="http://www.ti.com/clocks">www.ti.com/clocks</a>
Interface	<a href="http://interface.ti.com">interface.ti.com</a>
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